

Freescale Semiconductor Application Note

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Thermometer using a Thermistor with TWR-MCF51JF

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1 Introduction

This application note describes temperature control using any thermistor with the low-power feature of the MCF51JF128 ColdFire+ family of Freescale microcontrollers.

The ColdFire+ embedded controller ensures an optimal flow current and temperature measurement that maximizes the thermometer's life. Allowing an efficient temperature measurement avoids the environmental changes that affect hardware components.

2 Objective

The purpose of this application note is to present a way of controlling temperature by using a thermistor as a sensor for low power consumption, and to introduce the features of the new MCF51Jx device family, including: ADC, LPTMR, GPIO modules, and STOP management.

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Features

3 Features

This application note assumes the following:

- The MCF51JF128 ColdFire+ is used as the core system
- Measures temperature from -25 °C to +40 °C in 0.1 °C
- Conversion and average of temperature
- Low-power solution
- Thermistor is used as a temperature sensor
- System connection

4 Thermistor description

Thermistors are thermally sensitive semiconductors whose resistance varies with temperature. Because thermistors are sensitive, they require an excitation source and later read the voltage through its terminals. This source should be constant and accurate. Figure 1 is an illustration of the symbol typically used to represent a thermistor.



Figure 1. Common symbol for thermistors

The way to connect to a thermistor is shown in Figure 2. It explains the use of a voltage divider. The voltage difference in the resistor is read as the temperature.

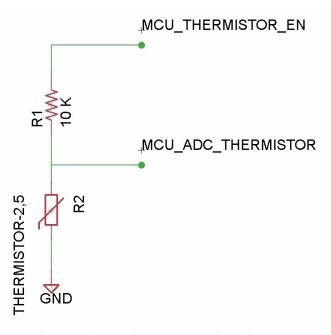


Figure 2. Thermistor connection diagram

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The relationship between voltage in a resistor and temperature is not perfectly linear. Each thermistor has a list of coefficients provided by the temperature sensor manufacturer that includes the resistance value with respect to the temperature. But sometimes these values are not known; in these cases, it is possible to calculate coefficient values for a thermistor, that approximate the manufacturer's values.

The calculation of coefficients to the thermistor used for this application note is based on the theory of Scarr and Setterington (1960), who proposed the following equation:

$$R(T) = R_0 \cdot e^{\beta \cdot \left(\frac{1}{T} - \frac{1}{T_0}\right)} = R_0 \cdot e^{\beta \cdot \left(\frac{T_0 - T}{T \cdot T_0}\right)}$$

The values obtained with the equation above can be found in Appendix A.

5 Thermometer description

5.1 Block diagram

The temperature control shown in Figure 3 and the processor use the internal CLK to 10 MHz. The MCU is configured to work in Low-Power mode. For more detailed information on configuration modes, consult document number MCF51JF128RM, MCF51JF128 Reference Manual.

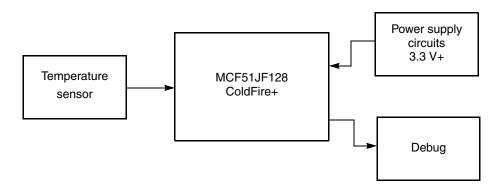


Figure 3. Thermometer block diagram

5.2 Firmware

The thermometer is initialized by configuring all peripherals and variables that will be used for the application: GPIO, ADC, MCG, and LPTMR, which is used for low power and delay for ADC conversions.

To measure temperature, the thermometer uses the circuit thermistor described above and the ADC. The Temp_Read.c module is the hardware abstraction layer (HAL) designed to configure the ADC. It provides functions to initialize the ADC, start conversion for any channel, and stop the ADC. The read data is stored in a buffer to later perform the temperature conversion in the hardware independent layer (HIL) block.

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Thermometer description

The thermometer application is designed in such a way that the MCU peripherals are independent of HIL modules.

The temperature measurement in the HIL block has the following functions:

- Enable thermistor circuit
- Read the ADC channel connected to the temperature sensor and convert this to a temperature value
- Perform the conversion and obtain the average temperature value and set the MCU in low-power Stop mode
- Wake the MCU from low-power and restart the temperature measurement

The flow chart in Figure 4 explains the function for the thermometer application process.



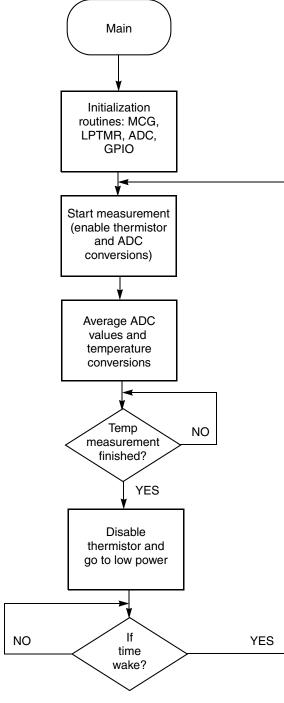


Figure 4. Thermometer software flowchart



Thermometer description

5.3 Thermometer functions

void main(void){...};

This function contains the application startup. It configures MCU peripherals and initializes the state machine to the temperature measurement.

void LPT0 Init(int count){...};

Low-power timer (LPTMR) registers are configured to operate as timer counter to 1 ms.

• interrupt void lpt0 isr(void){...};

Interruption used to wake the MCU out of low power once the LPTMR0_CNR reaches the module value.

void vfnRead Temp(void){...};

Called function that starts the temperature measurement each time, enables the thermistor, and performs the call for the temperature conversions.

• unsigned int Read Voltage Thermistor(void){...};

When a measurement is started, this function waits for ADC conversion and returns the value obtained.

void Init ADC(void){...};

Enables the ADC module for the conversion process and configures the ADC channel.

void End ADC(void){...};

Disables the ADC module and stops ADC conversions to save energy.

• void Sensor Read Process(unsigned int u16VoltageThermistor){...};

This function makes an average process which helps to obtain a stable voltage measurement to later calculate the temperature.

void vfnCalculate Temperature(void){...};

After determining the voltage across the resistor, this function controls the voltage-temperature conversion. The data obtained in the conversion is stored in a buffer that is averaged, resulting in the temperature value.

• int i16fnConversionProcess(void){...};

This function compares the value of the thermistor voltage with a coefficients table and obtains the temperature through the mathematical method of interpolation. The calculated value is returned as temperature in °C.

void enter stop(void){...};

It puts the processor into normal Stop mode. In this mode, core, bus, and peripheral clocks are disabled. Stop mode is exited using any enabled interrupt or RESET, so no exit_stop routine is needed



5.4 Macros and variables

```
#define PD Thermistor OUT PTA DD |= 0x40
                          PTA_D |= 0x40
#define P Thermistor ON
#define P_Thermistor_OFF PTA_D &= ~(0x40)
#define PD ADC OUT
                          PTD DD |= 0x20
#define P ADC OFF
                          PTD D &= \sim (0x20)
#define ADC CHANNEL
                                    12
#define AVERAGE DATA MAX
                                 /* average number data*/
#define ON
#define OFF
extern unsigned char u8Data ready; /* variable used to know if thermometer process finished*/
#define LED1 ON
                PTA D &= 0xFE
#define LED2 ON
                PTC D &= 0xDF
#define LED1 OFF
                 PTA D \mid = 0x01
#define LED2 OFF
                  PTC D \mid = 0x20
#define LED1 TOG if(PTA D & 0x01) PTA D &= 0xFE; else PTA D |= 0x01
#define LED2 TOG if(PTC D & 0x20) PTC D &= 0xDF; else PTC D |= 0x20
```

6 Conclusions

On any electronic device, it is important to save the electrical current consumption. This application note uses normal Stop mode for low power. The power consumption was reduced to 50%, which is very favorable:

- Power consumption not using Stop mode: 20 mA
- Power consumption using Stop mode: 10 mA

If used, the different power modes (VLPS, VLLS3, LLS, and so on) give better energy-saving results.



Appendix A

Table 1. Thermistor-to-temperature conversion values

Temperature (°C)	Res Thermistor Ohms	Voltage (V)	MCU Values
45.0	2199	0.59	185
42.0	2460	0.65	202
40.0	2653	0.69	215
37.0	2976	0.76	235
35.0	3216	0.80	249
32.0	3619	0.88	272
30.0	3919	0.93	288
27.0	4423	1.01	314
25.0	4800	1.07	332
22.0	5435	1.16	361
20.0	5910	1.23	380
17.0	6714	1.33	411
15.0	7318	1.39	433
12.0	8343	1.50	466
10.0	9115	1.57	488
7.0	10428	1.68	523
5.0	11420	1.76	546
2.0	13115	1.87	581
0.0	14400	1.95	604
-3.0	16601	2.06	639
-5.0	18276	2.13	662
-8.0	21156	2.24	695
-10.0	23356	2.31	717
-13.0	27151	2.41	748
-15.0	30061	2.48	768
-18.0	35101	2.57	797
-20.0	38981	2.63	815
-23.0	45728	2.71	840
-25.0	50944	2.76	856



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